



DATE 02 JUL 2007

NOTES:

- AUTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSION 6 APPLIES TO PLATED
- TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| | MILLIMETERS | | | |
|-----|-------------|------|------|--|
| DIM | MIN | NOM | MAX | |
| Α | 0.70 | 0.75 | 0.80 | |
| A1 | 0.00 | 0.03 | 0.05 | |
| A3 | 0.20 REF | | | |
| b | 0.18 | 0.24 | 0.30 | |
| D | 3.00 BSC | | | |
| D2 | 2.45 | 2.50 | 2.55 | |
| E | 3.00 BSC | | | |
| E2 | 1.75 | 1.80 | 1.85 | |
| е | 0.50 BSC | | | |
| K | 0.19 TYP | | | |
| L | 0.35 | 0.40 | 0.45 | |

GENERIC MARKING DIAGRAM*



Α = Assembly Location

= Wafer Lot L Υ = Year W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " •", may or may not be present.

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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| DESCRIPTION: | WDFN10 3X3, 0.5P | | PAGE 1 OF 1 | |

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